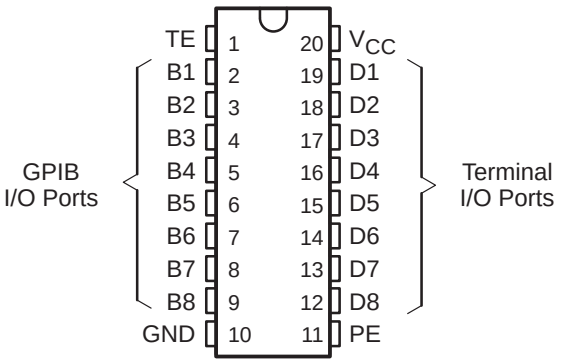
SLLS023B – JUNE 1986 – REVISED AUGUST 1989

MEETS IEEE STANDARD 488-1978 (GPIB)

- **8-Channel Bidirectional Transceiver**
- **High-Speed Advanced Low-Power Schottky Circuitry**
- **Low Power Dissipation . . . 46 mW Max Per Channel**
- **Fast Propagation Times . . . 20 ns Max**
- **High-Impedance PNP Inputs**
- **Receiver Hysteresis . . . 650 mV Typ**
- **No Loading of Bus When Device Is Powered Down (V_{CC} = 0)**
- **Power-Up/Power-Down Protection (Glitch Free)**
- **Driver and Receiver Can Be Disabled Simultaneously**

DW OR N PACKAGE
(TOP VIEW)



NOT RECOMMENDED FOR NEW DESIGN

Function Tables

EACH DRIVER

INPUTS			OUTPUT
D	TE	PE	B
H	H	H	H
L	H	X	L
H	X	L	Z†
X	L	X	Z†

EACH RECEIVER

INPUTS			OUTPUT
B	TE	PE	D
L	L	H	L
H	L	H	H
X	H	X	Z
X	X	L	Z

H = high level, L = low level, X = irrelevant,
Z = high-impedance state
† This is the high-impedance state of a normal 3-state output modified by the internal resistors to V_{CC} and GND.

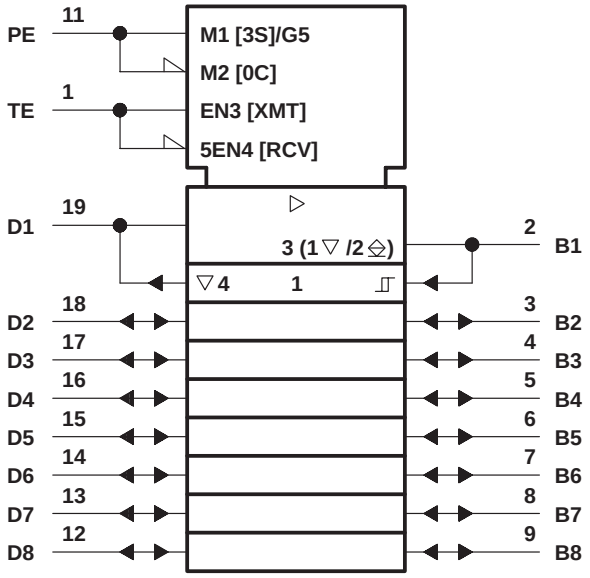
description

The SN75ALS165 eight-channel general-purpose interface bus transceiver is a monolithic, high-speed, advanced low-power Schottky device designed for two-way data communications over single-ended transmission lines. It is designed to meet the requirements of IEEE Standard 488-1978. The transceiver features driver outputs that can be operated in either the passive-pullup or 3-state mode. If talk enable (TE) is high, these ports have the characteristics of passive-pullup outputs when pullup enable (PE) is low and of 3-state outputs when PE is high. Taking TE low places these ports in the high-impedance state. Taking TE and PE low places both the drivers and receivers in the high-impedance state. The driver outputs are designed to handle loads up to 48 mA of sink current.

An active turn-off feature is incorporated into the bus-terminating resistors so that the device exhibits a high impedance to the bus when V_{CC} = 0. When combined with the SN75ALS161 or SN75ALS162 management bus transceiver, the pair provides the complete 16-wire interface for the IEEE 488 bus.

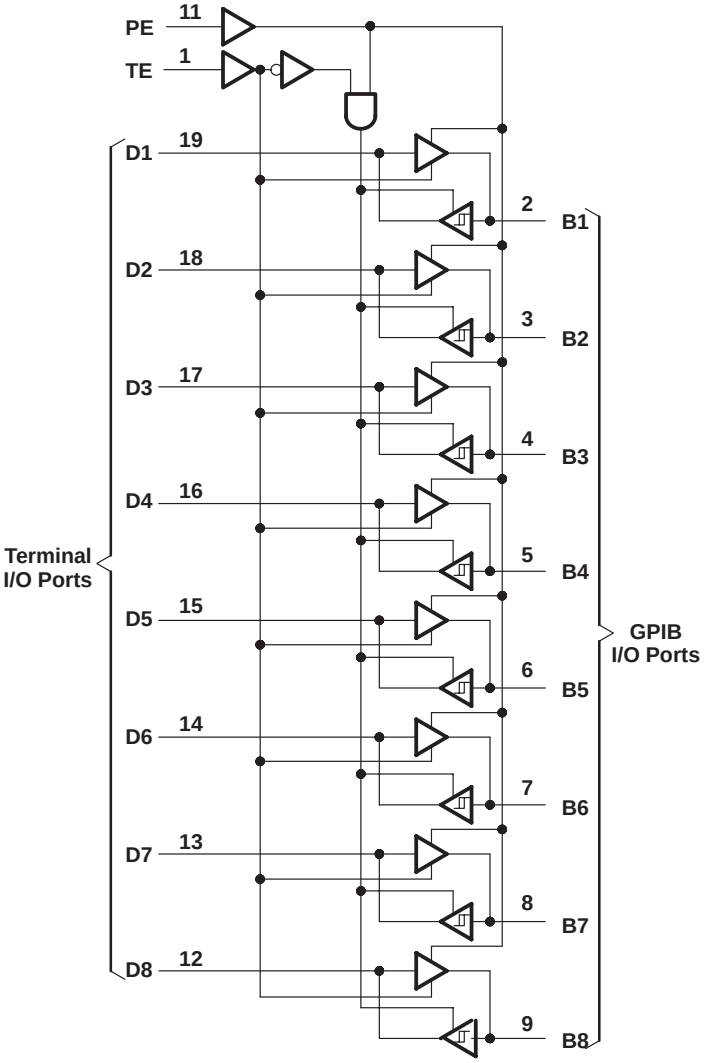
The SN75ALS165 is manufactured in a 20-pin package and is characterized for operation from 0°C to 70°C.

logic symbol†



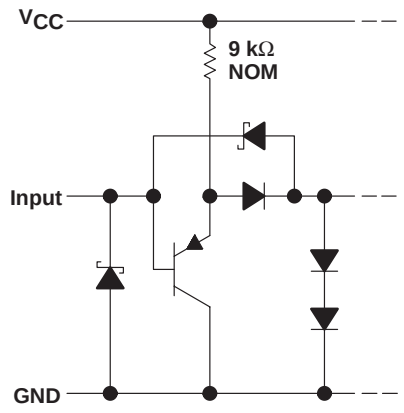
† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
▽ Designates 3-state outputs
◈ Designates passive-pullup outputs

logic diagram (positive logic)

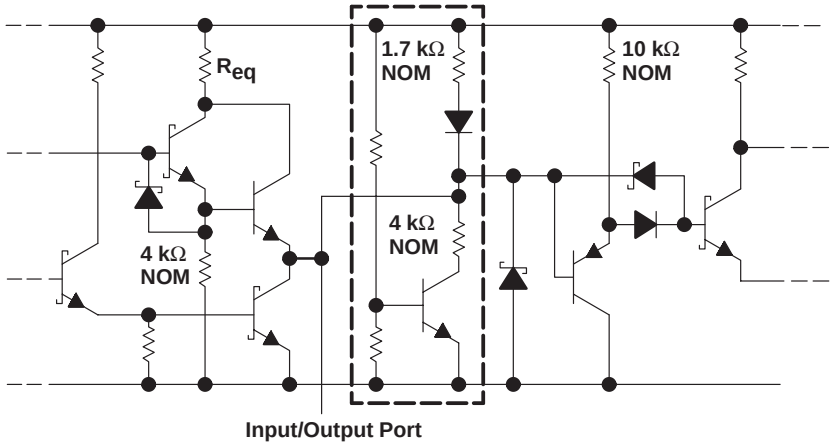


schematics of inputs and outputs

EQUIVALENT OF ALL CONTROL INPUTS



EQUIVALENT OF ALL INPUT/OUTPUT PORTS



Driver output R_{eq} = 30 Ω NOM
Receiver output R_{eq} = 110 Ω NOM
Circuit inside dashed lines is on the driver outputs only.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 5.5 V
Low-level driver output current . . . . . 100 mA
Continuous total power dissipation . . . . . See Dissipation Rating Table
Operating free-air temperature range . . . . . 0°C to 70°C
Storage temperature range . . . . . –65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from the case for 10 seconds . . . . . 260°C

NOTE 1: All voltage values are with respect to network ground terminal.

DISSIPATION RATING TABLE

PACKAGE	$T_A \le 25°C$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25°C$	$T_A = 70°C$ POWER RATING
DW	1025 mW	8.2 mW/°C	656 mW
N	1150 mW	9.2 mW/°C	736 mW

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}		4.75	5	5.25	V
High-level input voltage, V_{IH}		2			V
Low-level input voltage, V_{IL}				0.8	V
High-level output current, I_{OH}	Bus ports with pullups active			–5.2	mA
	Terminal ports			–800	µA
Low-level output current, I_{OL}	Bus ports			48	mA
	Terminal ports			16	
Operating free-air temperature, T_A		0		70	°C

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER			TEST CONDITIONS		MIN	TYP†	MAX	UNIT
V_{IK}	Input clamp voltage		I_I = –18 mA			–0.8	1.5	V
V_{hys}	Hysteresis ($V_{T+} - V_{T-}$)	Bus			0.4	0.65		V
V_{OH}‡	High-level output voltage	Terminal	I_{OH} = –800 µA,	TE at 0.8 V	2.7	3.5		V
		Bus	I_{OH} = –5.2 mA,	PE and TE at 2 V	2.5	3.3		
V_{OL}	Low-level output voltage	Terminal	I_{OL} = 16 mA,	TE at 0.8 V		0.3	0.5	V
		Bus	I_{OL} = 48 mA,	TE at 2 V		0.35	0.5	
I_I	Input current at maximum input voltage	Terminal	V_I = 5.5 V			0.2	100	µA
I_{IH}	High-level input current	Terminal and control inputs	V_I = 2.7 V			0.1	20	µA
I_{IL}	Low-level input current		V_I = 0.5 V			–10	–100	µA
$V_{I/O(bus)}$	Voltage at bus port		Driver disabled	$I_{I(bus)}$ = 0	2.5	3	3.7	V
				$I_{I(bus)}$ = –12 mA			–1.5	
$I_{I/O(bus)}$	Current into bus port	Power on	Driver disabled	$V_{I(bus)}$ = –1.5 V to 0.4 V	–1.3			mA
				$V_{I(bus)}$ = 0.4 V to 2.5 V	0		–3.2	
				$V_{I(bus)}$ = 2.5 V to 3.7 V			2.5 –3.2	
				$V_{I(bus)}$ = 3.7 V to 5 V	0		2.5	
				$V_{I(bus)}$ = 5 V to 5.5 V	0.7		2.5	
		Power off	V_{CC} = 0,	$V_{I(bus)}$ = 0 to 2.5 V			40	µA
I_{OS}	Short-circuit output current	Terminal			–15	–35	–75	mA
		Bus			–25	–50	–125	
I_{CC}	Supply current		No load	Terminal outputs low and enabled		42	65	mA
				Bus outputs low and enabled		52	80	
$C_{I/O(bus)}$	Bus-port capacitance		V_{CC} = 5 V to 0,	$V_{I/O}$ = 0 to 2 V, f = 1 MHz		30		pF

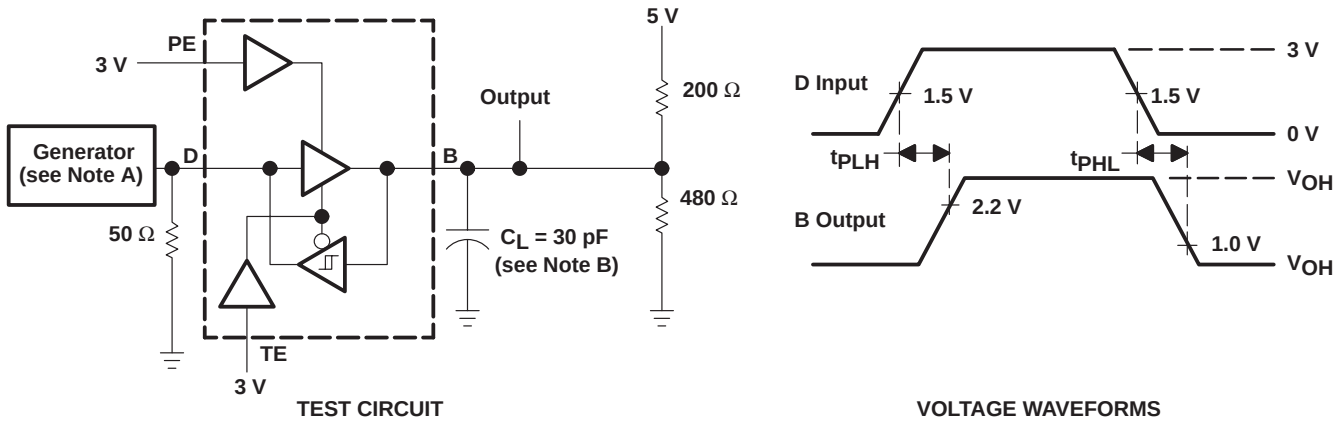
† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ V_{OH} applies for 3-state outputs only.

switching characteristics over recommended range of operating free-air temperature (unless otherwise noted), V_{CC} = 5 V

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP†	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high-level output	Terminal	Bus	C_L = 30 pF, See Figure 1		7	20	ns
t_{PHL}	Propagation delay time, high-to-low-level output					8	20	
t_{PLH}	Propagation delay time, low-to-high-level output	Bus	Terminal	C_L = 30 pF, See Figure 2		7	14	ns
t_{PHL}	Propagation delay time, high-to-low-level output					9	14	
t_{PZH}	Output enable time to high level	TE	Bus	C_L = 15 pF, See Figure 3		19	30	ns
t_{PHZ}	Output disable time from high level					5	12	
t_{PZL}	Output enable time to low level					16	35	
t_{PLZ}	Output disable time from low level					9	20	
t_{PZH}	Output enable time to high level	TE	Terminal	C_L = 15 pF, See Figure 4		13	30	ns
t_{PHZ}	Output disable time from high level					12	20	
t_{PZL}	Output enable time to low level					12	20	
t_{PLZ}	Output disable time from low level					11	20	
t_{en}	Output pullup enable time	PE	Terminal	C_L = 15 pF, See Figure 5		11	22	ns
t_{dis}	Output pullup disable time					6	12	

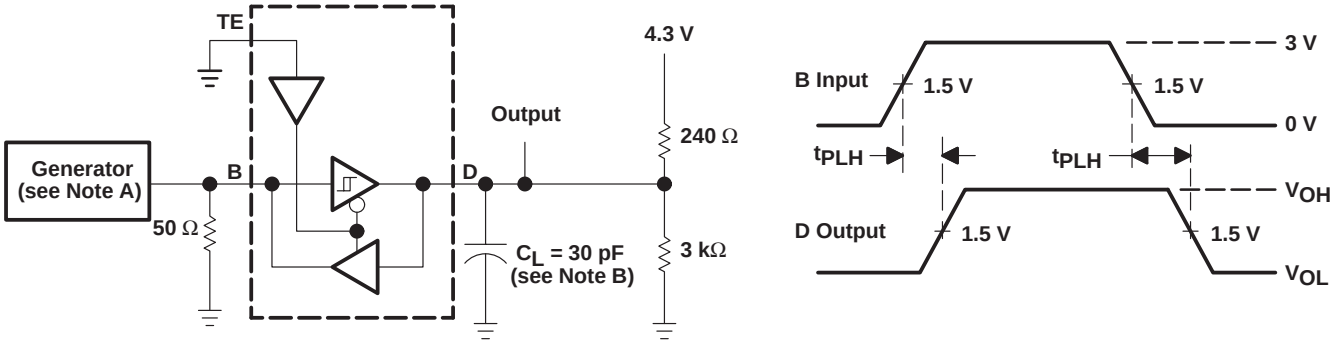
† All typical values are at T_A = 25°C.

PARAMETER MEASUREMENT INFORMATION



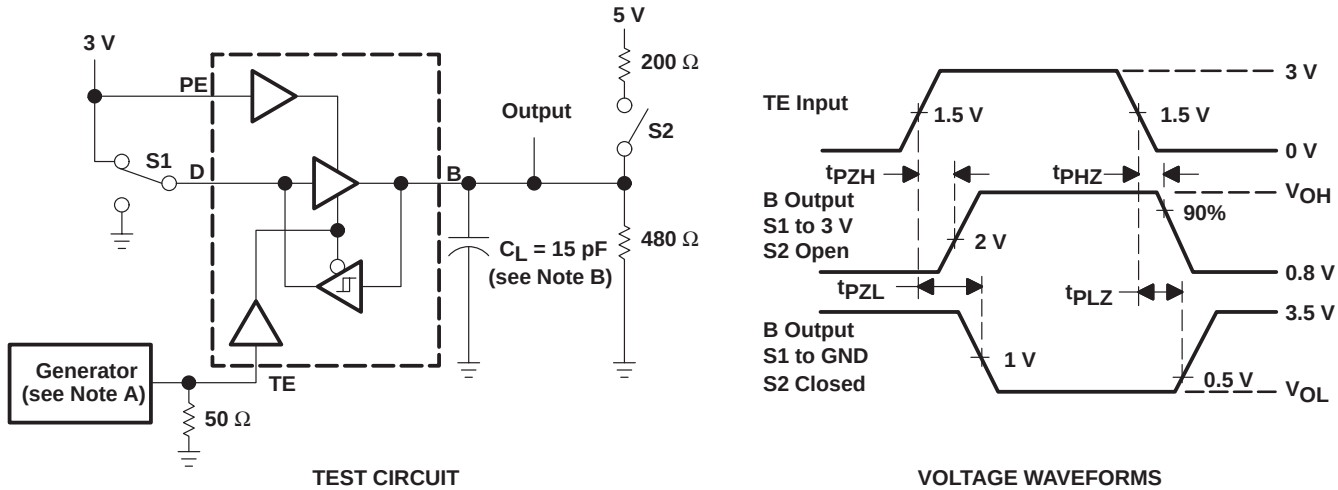
TEST CIRCUIT VOLTAGE WAVEFORMS

Figure 1. Terminal-to-Bus Test Circuit and Voltage Waveforms



TEST CIRCUIT VOLTAGE WAVEFORMS

Figure 2. Bus-to-Terminal Test Circuit and Voltage Waveforms

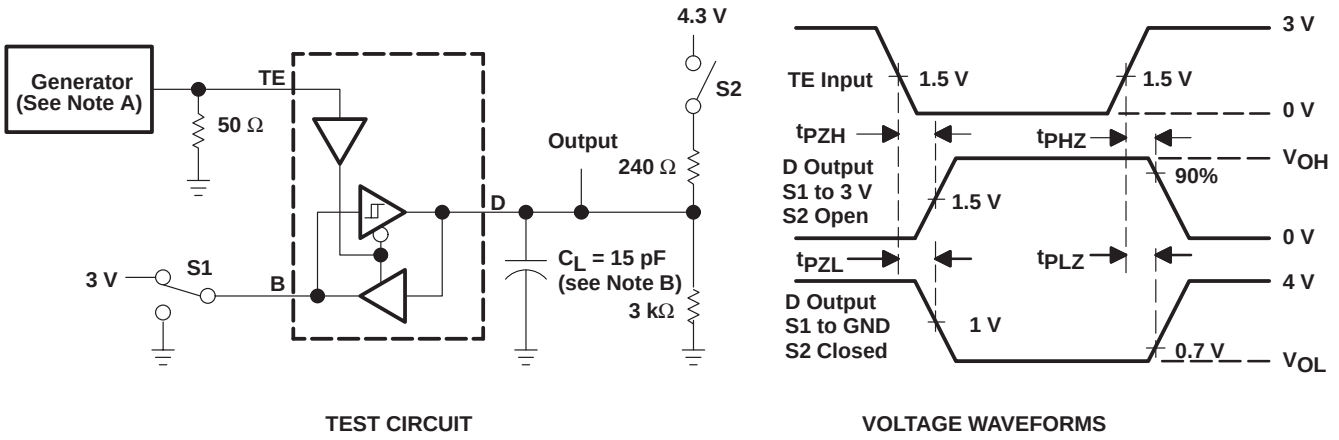


TEST CIRCUIT VOLTAGE WAVEFORMS

Figure 3. TE-to-Bus Test Circuit and Voltage Waveforms

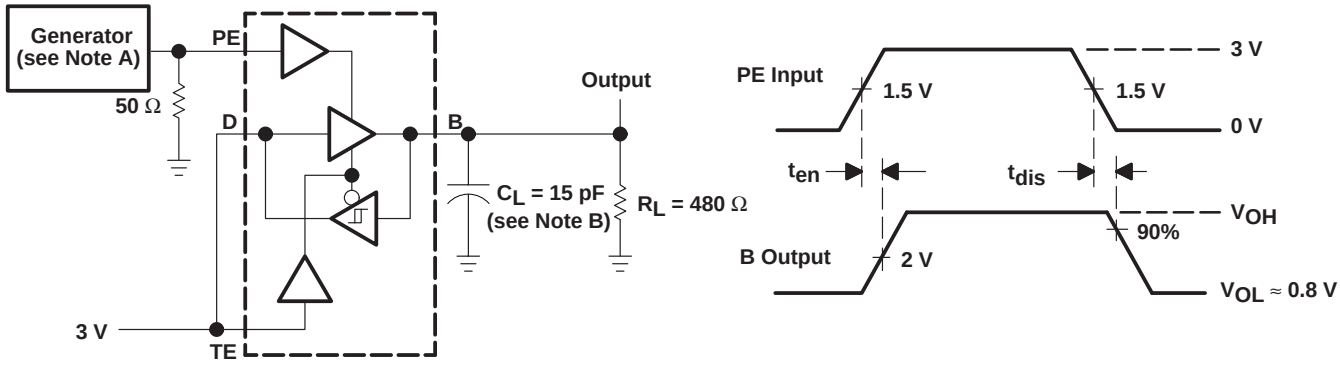
NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR ≤ 1 MHz, 50% duty cycle, t_r ≤ 6 ns, t_f ≤ 6 ns, Z_O = 50 Ω.
B. C_L includes probe and jig capacitance.

PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT VOLTAGE WAVEFORMS

Figure 4. TE-to-Terminal Test Circuit and Voltage Waveforms



TEST CIRCUIT VOLTAGE WAVEFORMS

Figure 5. PE-to-Bus Test Circuit and Voltage Waveforms

NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR ≤ 1 MHz, 50% duty cycle, t_r ≤ 6 ns, t_f ≤ 6 ns, Z_O = 50 Ω.
B. C_L includes probe and jig capacitance.

TYPICAL CHARACTERISTICS

TERMINAL HIGH-LEVEL OUTPUT VOLTAGE vs HIGH-LEVEL OUTPUT CURRENT

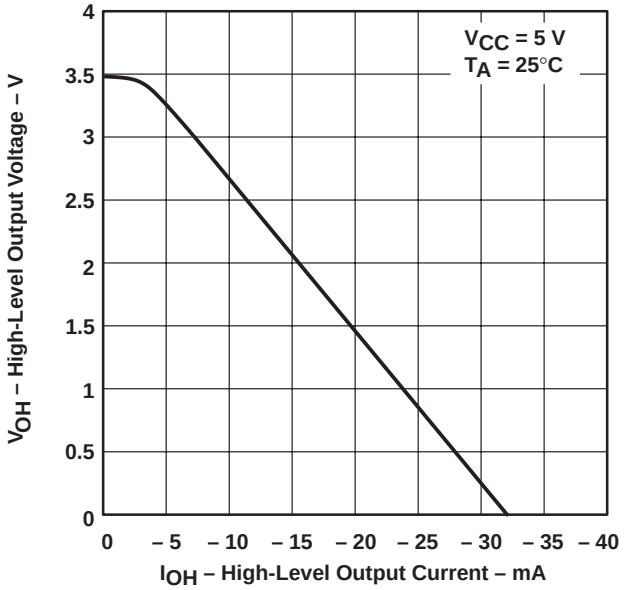


Figure 6

TERMINAL LOW-LEVEL OUTPUT VOLTAGE vs LOW-LEVEL OUTPUT CURRENT

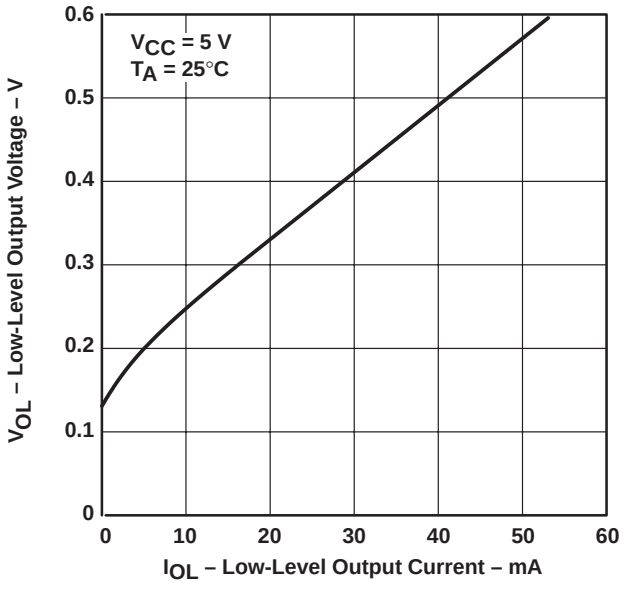


Figure 7

TERMINAL OUTPUT VOLTAGE vs BUS INPUT VOLTAGE

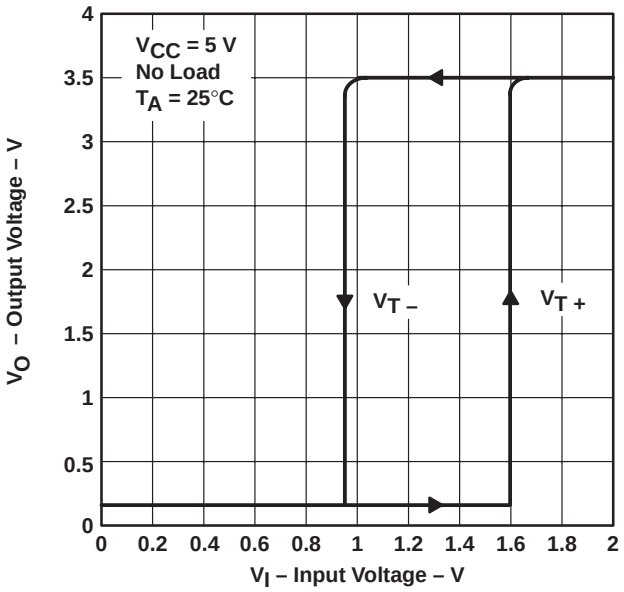


Figure 8

TYPICAL CHARACTERISTICS

BUS HIGH-LEVEL OUTPUT VOLTAGE vs BUS HIGH-LEVEL OUTPUT CURRENT

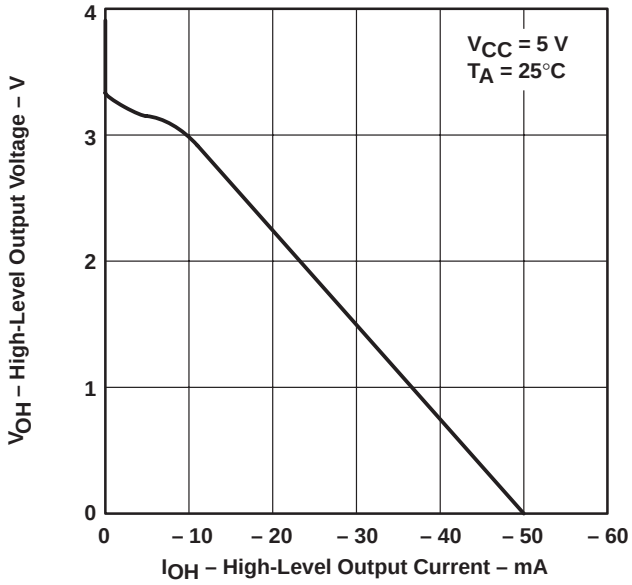


Figure 9

BUS LOW-LEVEL OUTPUT VOLTAGE vs BUS LOW-LEVEL OUTPUT CURRENT

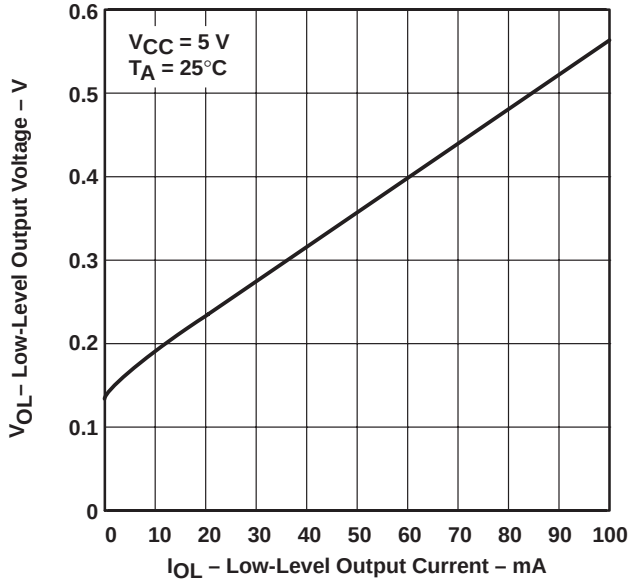


Figure 10

BUS OUTPUT VOLTAGE vs TERMINAL INPUT VOLTAGE

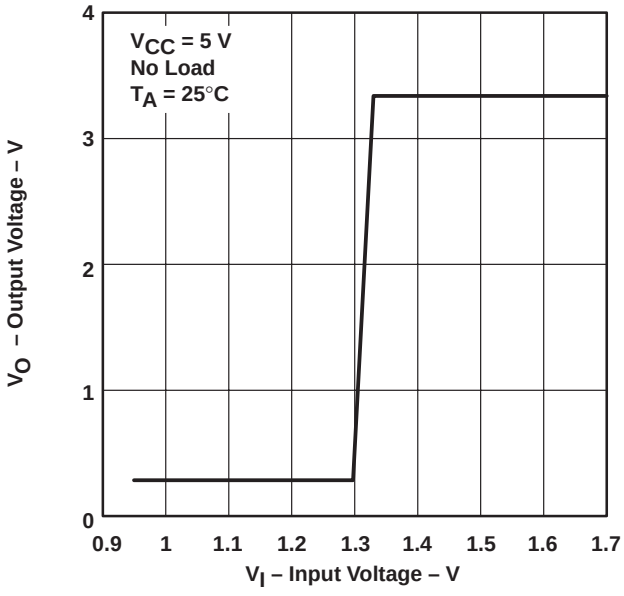


Figure 11

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
SN75ALS165DW	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI
SN75ALS165N	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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